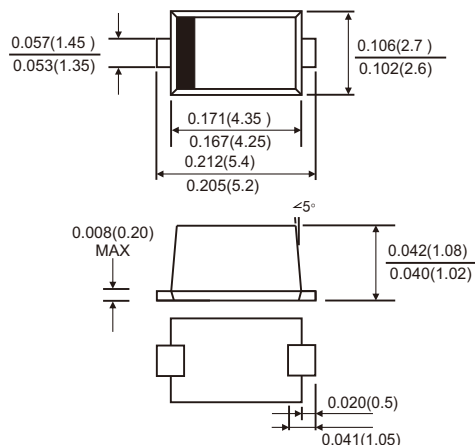


FEATURES

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Metal silicon junction ,majority carrier conduction
- Guard ring for overvoltage protection
- Low power loss ,high efficiency
- High current capability ,low forward voltage drop
- High surge capability
- High temperature soldering guaranteed:260°C/10 seconds at terminals
- Component in accordance to RoHS 2011/65/EU



SMAFL



Dimensions in inches and (millimeters)

MECHANICAL DATA

- Case: SMAFL molded plastic body
- Terminals: Solder Plated, solderable per MIL-STD-750,method 2026
- Polarity: Color band denotes cathode end
- Weight: 0.0012ounce, 0.0328 gram

TYPICAL APPLICATIONS

For use in low voltage ,high frequency inverters ,DC/DC converters, free wheeling ,and polarity protection applications

MAXIMUM RATINGS

(Ratings at 25°C ambient temperature unless otherwise specified)

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	2.0A
V_{RRM}	100V
I_{FSM}	50A
V_F at $I_F=2.0A, 25^\circ C$	0.62V
T_{JMAX}	150°C

Parameter	Symbol	Value	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	100	V
Maximum average forward rectified current 0.375"(9.5mm) lead length(see fig.1)	$I_{F(AV)}$	2.0	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method at rated TL)	I_{FSM}	50	A
Operating junction temperature range	T_J	-55 to+150	°C
Storage temperature range	T_{stg}	-55 to+150	°C

RATINGS AND CHARACTERISTIC OF SS210LT

ELECTRICAL CHARACTERISTICS (T_A=25°C Unless otherwise noted)

Parameter	Test Conditions		Symbol	TYP.	MAX.	Unit
Instantaneous forward voltage	I _F =2.0A	T _A =25°C	V _F ¹⁾	0.62	0.65	V
		T _A =100°C		0.59	-	
		T _A =125°C		0.57	-	
Reverse current	V _R =100V	T _A =25°C	I _R ²⁾	20	50	μA
		T _A =100°C		2	-	mA
		T _A =125°C		10	-	
Typical junction capacitance	4V, 1MHz		C _J	50		pF

Notes: 1.Pulse test: 300 μs pulse width, 1% duty cycle

2.Pulse test: pulse width ≤ 40ms

THERMAL CHARACTERISTICS

Parameter	Symbol	SMAFL	Unit
Typical thermal resistance	R _{θJA} ^{3) 4)}	115	°C/W
	R _{θJL} ³⁾	28	

3.Free air, mounted on recommended PCB, 2 oz.pad area

4.The heat generated must be less than thermal conductivity from junction to ambient: dP/dt_J < 1/R_{θJA}

AVAILABLE PACK INFORMATION

Product code	Pack	Reel Size (mm)	Quantity (pcs/reel)	Box Size L×W×H (mm)	Quantity (reel/box)	Carton Size L×W×H (mm)	Quantity (box/carton)
SS210LT-SMAFL	T/R	Φ280	5000	285×285×40	2	305×305×440	10
SS210LT-SMAFL	T/R	Φ180	3000	185×185×80	4	305×305×440	5

RATINGS AND CHARACTERISTIC OF SS210LT

FIG.1-FORWARD CURRENT DERATING CURVE

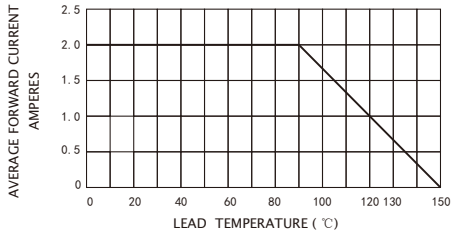


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

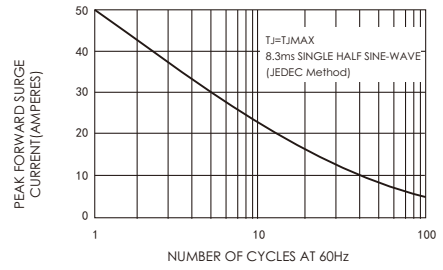


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

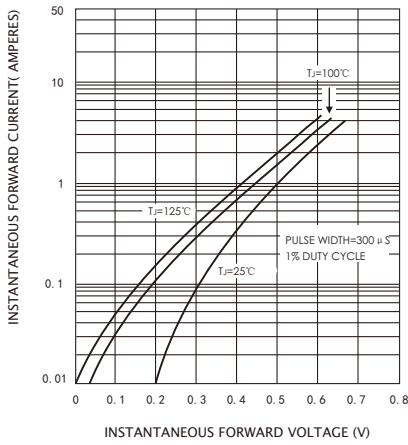


FIG.4-TYPICAL REVERSE CHARACTERISTICS

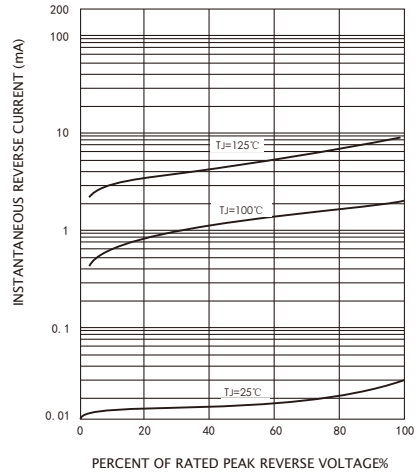


FIG.5-TYPICAL JUNCTION CAPACITANCE

